

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
NAOKI FUKUSHIMA	02/26/2019
OSAMU NAKAYAMA	02/26/2019
KATSUSHI MIYAZAKI	02/27/2019
TETSUYA FUJITA	03/05/2019
RECEIVING PARTY DATA	
Name:	AUTONETWORKS TECHNOLOGIES, LTD.
Street Address:	1-14 NISHISUEHIRO-CHO, YOKKAICHI
City:	MIE
State/Country:	JAPAN
Postal Code:	510-8503
Name:	SUMITOMO WIRING SYSTEMS, LTD.
Street Address:	1-14 NISHISUEHIRO-CHO, YOKKAICHI
City:	MIE
State/Country:	JAPAN
Postal Code:	510-8503
Name:	SUMITOMO ELECTRIC INDUSTRIES, LTD.
Street Address:	5-33 KITAHAMA 4-CHOME, CHUO-KU, OSAKA-SHI
City:	OSAKA
State/Country:	JAPAN
Postal Code:	541-0041
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16357839
CORRESPONDENCE DATA	
Fax Number:	(703)716-1180
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	703-716-1191
Email:	gbpatent@gbpatent.com

Correspondent Name: GREENBLUM & BERNSTEIN, P.L.C.
Address Line 1: 1950 ROLAND CLARKE PLACE
Address Line 4: RESTON, VIRGINIA 20191

ATTORNEY DOCKET NUMBER:	P56671
NAME OF SUBMITTER:	DANIEL B. MOON
SIGNATURE:	/Daniel B. Moon/
DATE SIGNED:	03/19/2019
	This document serves as an Oath/Declaration (37 CFR 1.63).

Total Attachments: 7
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COMBINED INVENTOR'S DECLARATION AND ASSIGNMENT**DECLARATION**

The herein-identified application was made or authorized to be made by me.

I believe I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

Authorization to Permit Access to Application by Participating Office

If checked, the undersigned hereby grants the USPTO authority to provide the European Patent Office (EPO), the Korean Intellectual Property Office (KIPO), the State Intellectual Property Office of the People's Republic of China (SIPO), the World Intellectual Property Office (WIPO), and any other intellectual property offices in which a foreign application claiming priority to the herein-identified patent application is filed access to the herein-identified patent application. See 37 CFR 1.14(c) and (h). This box should not be checked if the applicant does not wish the EPO, KIPO, SIPO, WIPO, or other intellectual property office in which a foreign application claiming priority to the herein-identified patent application is filed to have access to the herein-identified patent application.

In accordance with 37 CFR 1.14(h)(3), access will be provided to a copy of the herein-identified patent application with respect to: 1) the herein-identified patent application-as-filed; 2) any foreign application to which the herein-identified patent application claims priority under 35 U.S.C. 119(a)-(d) if a copy of the foreign application that satisfies the certified copy requirement of 37 CFR 1.55 has been filed in the herein-identified patent application; and 3) any U.S. application-as-filed from which benefit is sought in the herein-identified patent application.

In accordance with 37 CFR 1.14(c), access may be provided to information concerning the date of filing the Authorization to Permit Access to Application by Participating Offices.

The undersigned hereby authorizes the U.S. attorney or agent appointed herein to accept and follow instructions from either his foreign patent agent or corporate representative, if any, as to any action to be taken in the Patent and Trademark Office regarding this application without direct communication between the U.S. attorney or agent and the undersigned.

Direct Correspondence to: **CUSTOMER NUMBER 07055**

At: Greenblum & Bernstein, P.L.C.
1950 Roland Clarke Place
Reston, VA 20191

Direct Telephone Calls to: Greenblum & Bernstein, P.L.C. (703) 716-1191

ASSIGNMENT

WHEREAS, **Naoki FUKUSHIMA**, a resident of Mie, JAPAN, whose mailing address is c/o AutoNetworks Technologies, Ltd., 1-14, Nishisuehiro-cho, Yokkaichi, Mie, 510-8503 JAPAN, **Osamu NAKAYAMA**, a resident of Mie, JAPAN, whose mailing address is c/o AutoNetworks Technologies, Ltd., 1-14, Nishisuehiro-cho, Yokkaichi, Mie, 510-8503 JAPAN, **Katsushi MIYAZAKI**, a resident of Mie, JAPAN, whose mailing address is c/o AutoNetworks Technologies, Ltd., 1-14, Nishisuehiro-cho, Yokkaichi, Mie, 510-8503 JAPAN and **Tetsuya FUJITA**, a resident of Mie, JAPAN, whose mailing address is c/o Sumitomo Wiring Systems, Ltd., 1-14, Nishisuehiro-cho, Yokkaichi, Mie, 510-8503 JAPAN, hereinafter referred to as the ASSIGNORS, have invented a certain improvement relating to

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for which they have jointly executed, on the same date as this assignment, an application for Letters Patent of the United States to be filed in the United States Patent and Trademark Office.

If this Assignment is filed after the filing date of the above-identified application, the undersigned hereby authorize and request any one of the practitioners of record in this application associated with Customer No. 07055 including Neil F. Greenblum, Reg. No. 28,394, Bruce H. Bernstein, Reg. No. 29,027, Arnold Turk, Reg. No. 33,094, James L. Rowland, Reg. No. 32,674, Stephen M. Roylance, Reg. No. 31,296, Robert W. Mueller, Reg. No. 35,043, William E. Lyddane, Reg. No. 41,568, William S. Boshnick, Reg. No. 44,550, Sean C. Myers-Payne, Reg. No. 42,920, Daniel B. Moon, Reg. No. 48,124, Steven B. Pollicoff, Reg. No. 60,311, James P. Bonnamy, Reg. No. 63,649, Jonathan R. Miller, Reg. No. 59,834 and Walter A. Schlapkohl, Reg. No. 64,416, of the firm Greenblum & Bernstein, P.L.C., whose address is 1950 Roland Clarke Place, Reston, Virginia 20191, to insert here in parenthesis (Application No. _____, filed _____) the filing date and application number of said application when known.

AND WHEREAS, **AUTONETWORKS TECHNOLOGIES, LTD.**, a corporation organized and existing under the laws of JAPAN, whose mailing address is 1-14 Nishisuehiro-cho, Yokkaichi, Mie 510-8503 JAPAN, **SUMITOMO WIRING SYSTEMS, LTD.**, a corporation organized and existing under the laws of JAPAN, whose mailing address is 1-14 Nishisuehiro-cho, Yokkaichi, Mie 510-8503 JAPAN and **SUMITOMO ELECTRIC INDUSTRIES, LTD.**, a corporation organized and existing under the laws of JAPAN, whose mailing address is 5-33 Kitahama 4-chome, Chuo-ku, Osaka-shi, Osaka, 541-0041 JAPAN, hereinafter known as the ASSIGNEES, are each desirous of acquiring an equal undivided interest in the entire right, title and interest for the United States in and to said invention and application, including any and all divisions and continuations thereof, and any and all Letters Patent which may be granted thereon, including any and all renewals, reissues, reexaminations, and prolongations thereof.

NOW, THIS WITNESSETH that for good and valuable consideration, the receipt whereof is hereby acknowledged, said ASSIGNORS hereby assign, sell and transfer to said ASSIGNEES, their assigns and legal representatives, the entire and exclusive right, title and interest in and to said invention and application, for the United States including any and all divisions and continuations thereof, and any and all Letters Patent which may be granted therefor and all rights to sue for past and future infringement thereunder, said ASSIGNEES and their assigns and legal representatives to have, hold, exercise and enjoy the said invention and application, including any and all divisions and continuations thereof, and any and all Letters Patent which may be granted thereon, including any and all renewals, reissues, reexaminations, and prolongations thereof, with all the rights, powers, privileges, and advantages in any ways arising from or pertaining thereto, for and during the term or terms of any and all such Letters Patent when granted, including any and all renewals, reissues, reexaminations, and prolongations thereof, for the use and benefit of said ASSIGNEES and their assigns and legal representatives in as ample and beneficial a manner to all intents and purposes as the said ASSIGNORS might or could have held and enjoyed the same, if this assignment had not been made.

AND said ASSIGNORS hereby agree to execute all papers necessary to file applications in the United States for said invention and to assign the same to said ASSIGNEES, or any assignee acquiring title to said invention, and to execute any other papers that may be needed in connection with filing said application and securing Letters Patent thereon.

AND said ASSIGNORS authorize and request the Commissioner of Patents to issue Letters Patent on said application, and on any and all divisions and continuations thereof, to said ASSIGNEES, their assigns and legal representatives, in accordance herewith.

IN TESTIMONY WHEREOF, this assignment is executed by said ASSIGNORS, on the respective dates indicated below.

First Witness (Optional):

(Name)

(Date)

Naoki FUKUSHIMA

Naoki FUKUSHIMA

February 26, 2019
Date

Second Witness (Optional):

(Name)

(Date)

First Witness (Optional):

(Name)

(Date)

Osamu Nakayama
Osamu NAKAYAMA
February 26, 2019
Date

Second Witness (Optional):

(Name)

(Date)

First Witness (Optional):

(Name)

(Date)

Katsushi Miyazaki
Katsushi MIYAZAKI

February 27, 2019
Date

Second Witness (Optional):

(Name)

(Date)

First Witness (Optional):

(Name)

(Date)

Tetsuya Fujita
Tetsuya FUJITA

March 5, 2019
Date

Second Witness (Optional):

(Name)

(Date)